



Beam Cal

Testbeam Results for sCVD, pCVD and GaAs Sensors

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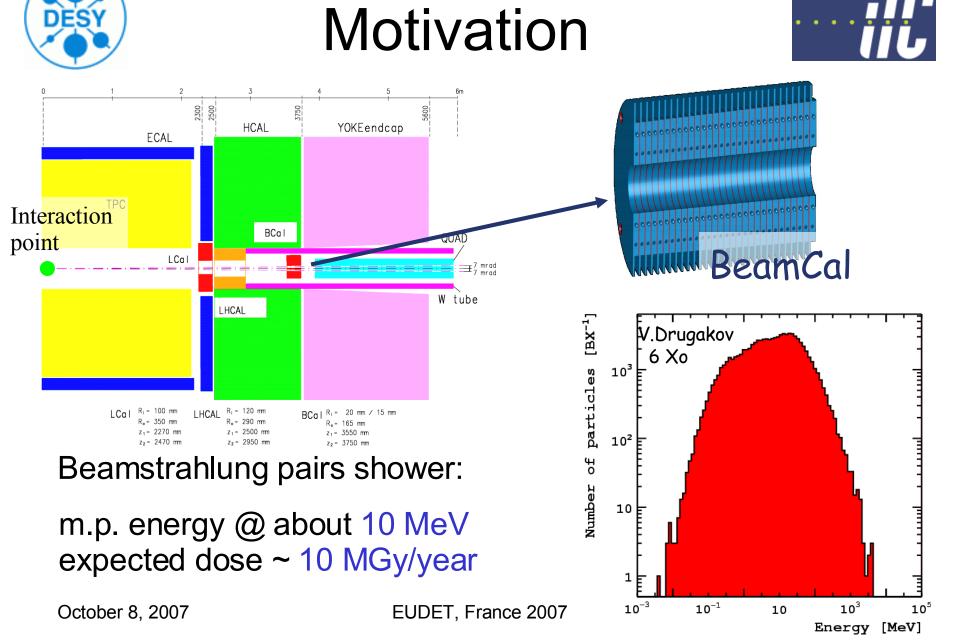
October 8, 2007



Outline



- Motivation
- Testbeam Darmstadt 2007
- sCVD Sensors
- pCVD Sensors
- GaAs Sensors
- Polarization effects (sCVD)
- Sensor -> detector sensor plane





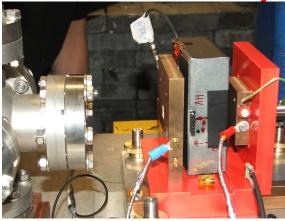
Testbeam Darmstadt

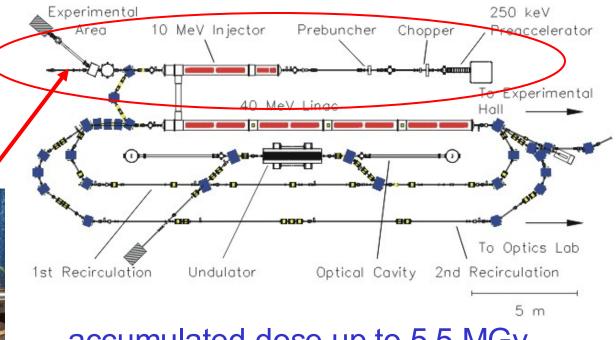


End of June 2007

supported by many FCAL members and collaborators

Teastbeam Setup





10 MeV electrons

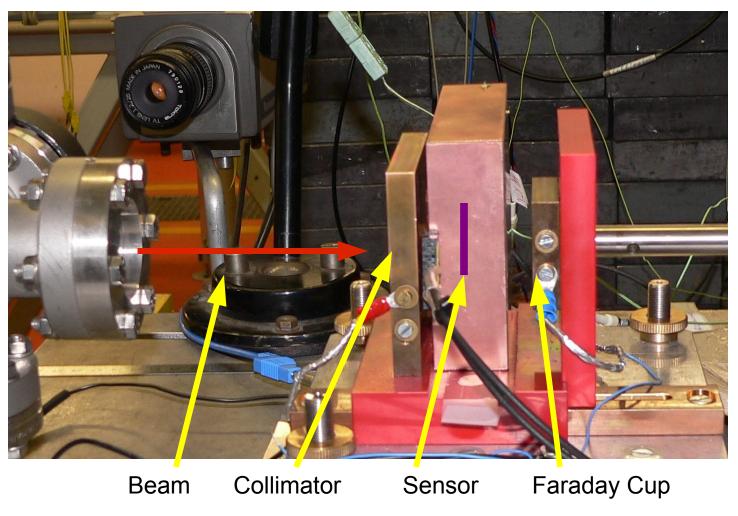
accumulated dose up to 5.5 MGy per sample

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Testbeam Setup



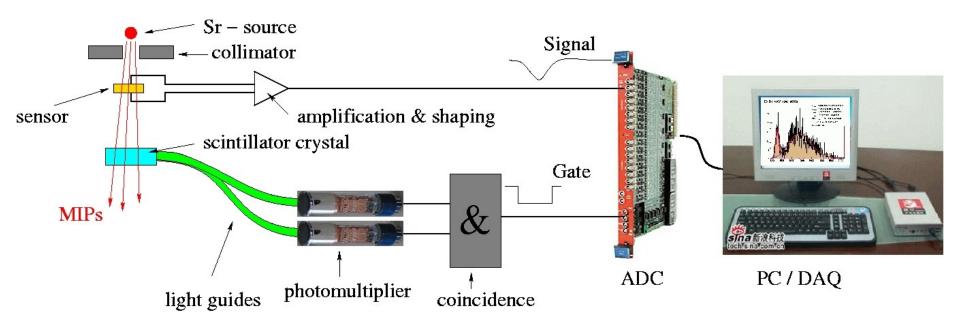


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CCD Setup





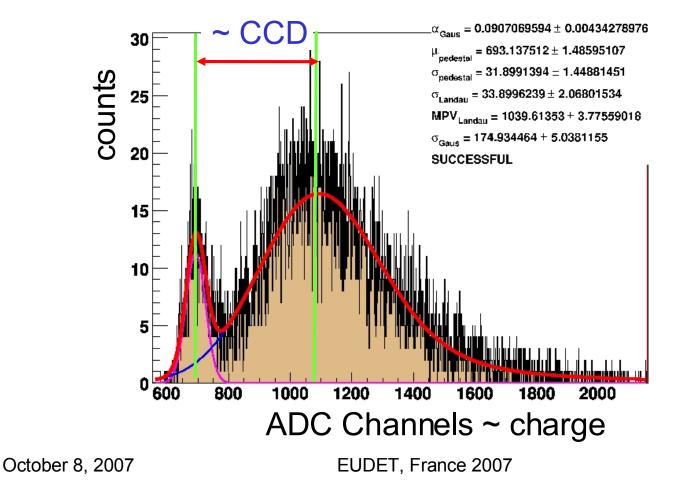
voltage applied on the sensor sample all the time



CCD



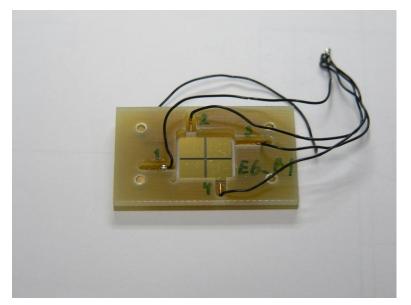
- CCD = mean drift distance
- related to collected charge via Ramo's theorem





CVD diamond samples







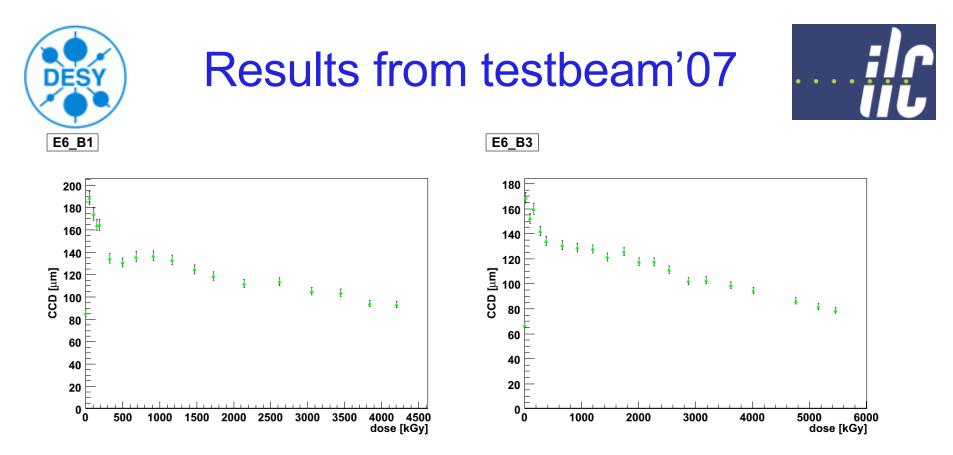
scCVD diamond area 5x5 mm², thickness 340 μm, metallization Ø3mm

0 SO14-10

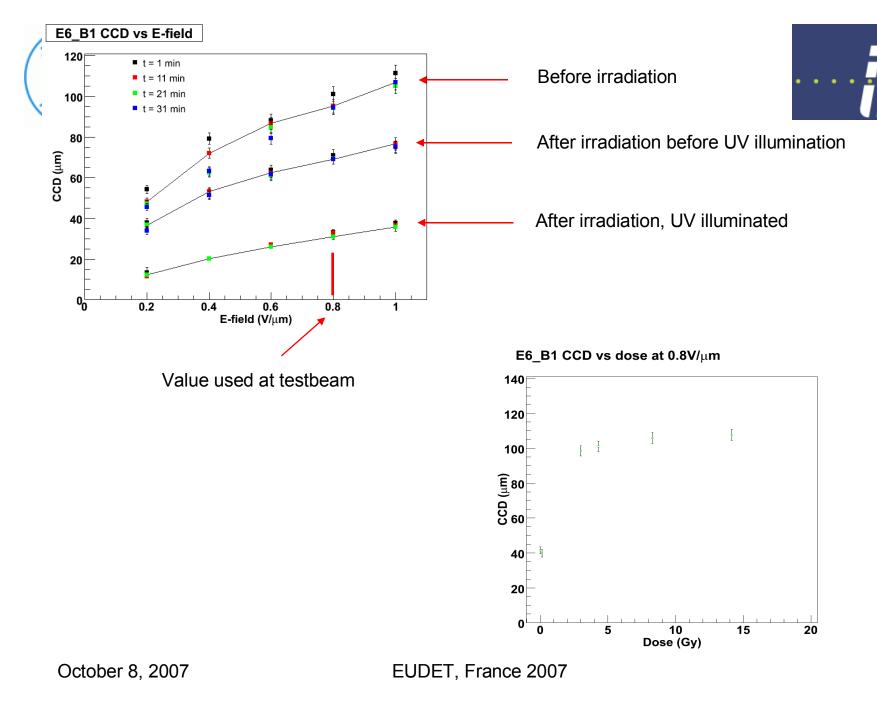
Irradiated up to 5.5 MGy

Irradiated up to 2.7 MGy

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Similar behavior: first pumping, then the CCD decreases

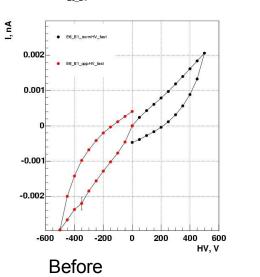


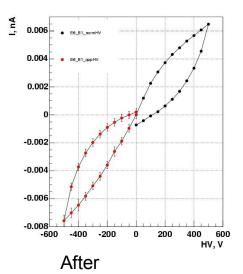


E6_B1

E6_B1







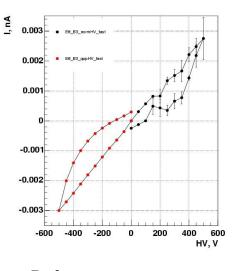
E6_B3

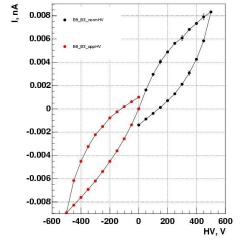
E6_B3_normHV

0.008







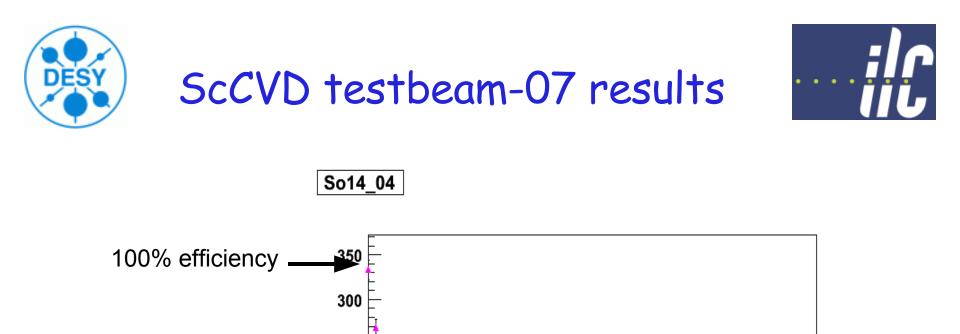


Before

After

EUDET, France 2007

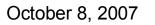
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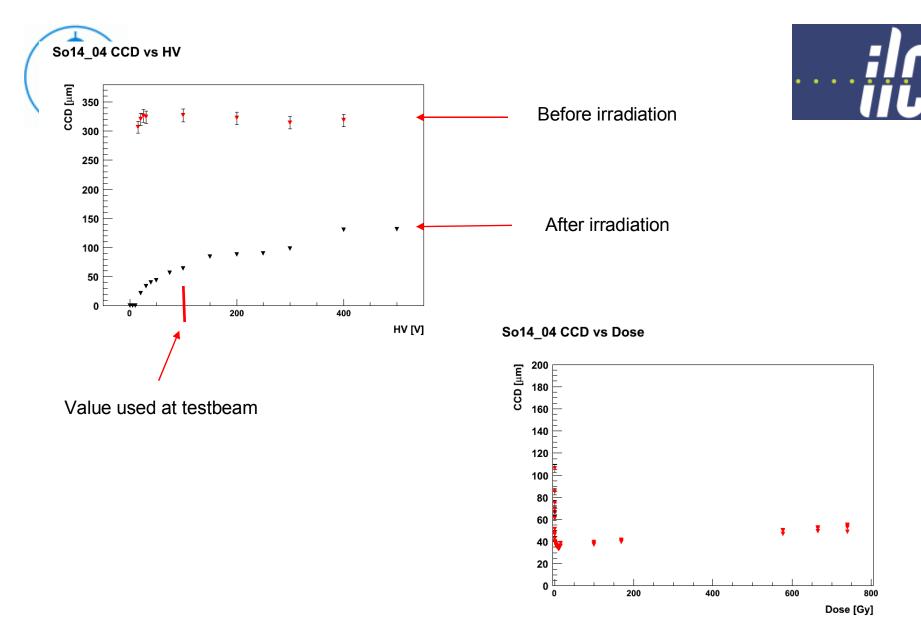
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dose (kGy)

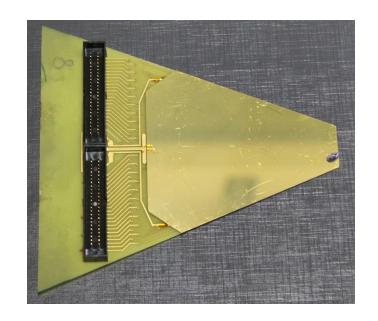




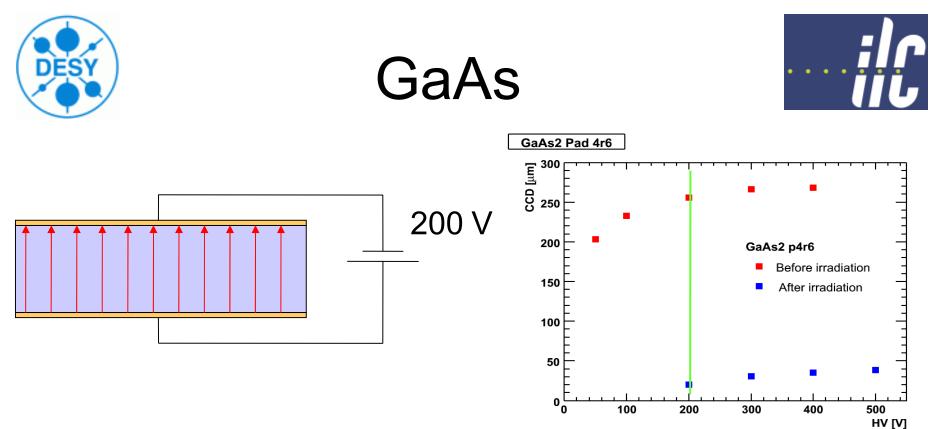




- Supplied by FCAL group at JINR
- Produced by Siberian Institute of Technology, Tomsk
- Two samples
- semi-insulating GaAs doped by Sn (shallow donor)
- compensated by Cr (deep acceptor)

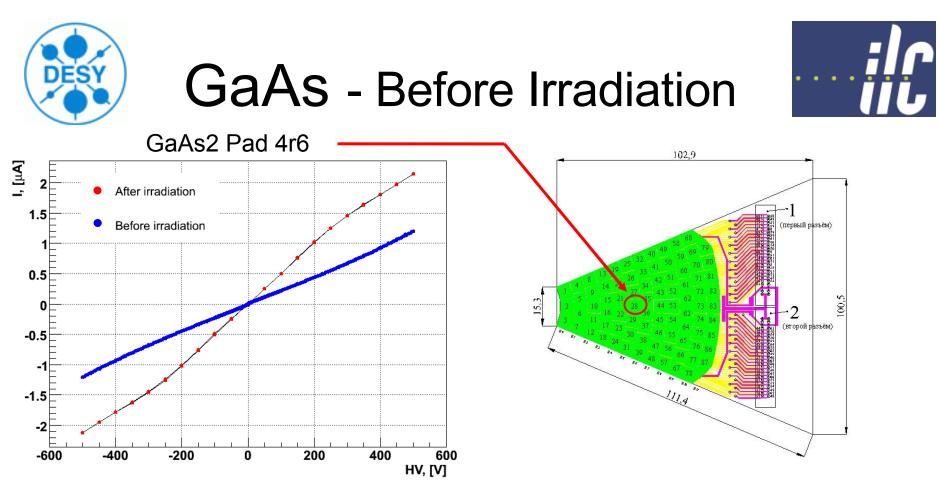


Irradiated up to 0.9 MGy



500 μm thick detector is divided into 87 5x5 mm pads, mounted on a 0.5 mm PCB with fanout
Metallisation is V (30 nm) + Au (1 μm)
works as a solid state ionisation chamber; signal eh pairs drifting in the E field

structure provided by metallisation (similar to diamond)



Almost linear IV characteristics \rightarrow ohmic resistor R_{pad} \approx 500 MΩ, Pad capacity about 12 pF, Dark Current 1 µA @ 500 V

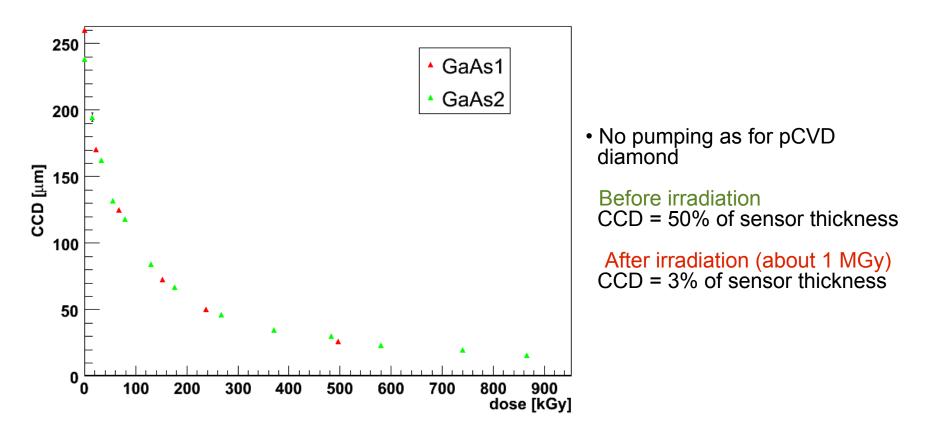
IV curve = temperature dependend due to semi-conducting character

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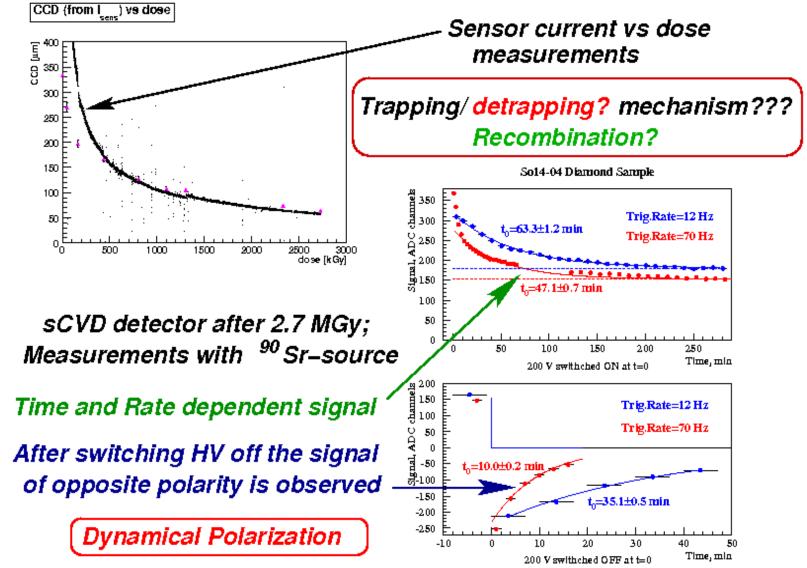








Experimental Data





Polarization Model



Radiation damage – uniformly produced traps MIP signal – uniformly produced e–h pairs +Electric field >> NONUNIFORM space charge Change of the electric field e–h Recombination if the field is low Release of trapped charges (decay time) Change of the space charge distribution

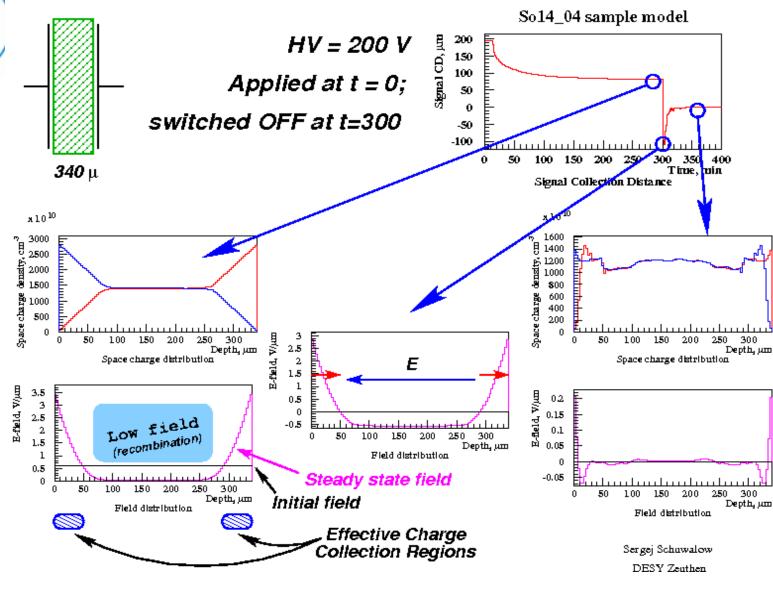
Steady state POLARIZATION

Dependent on trap density, applied voltage and signal rate

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Polarization Model: CCD vs time



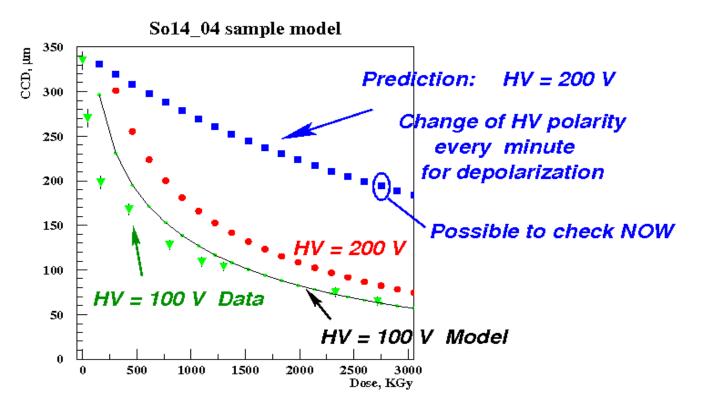
DES



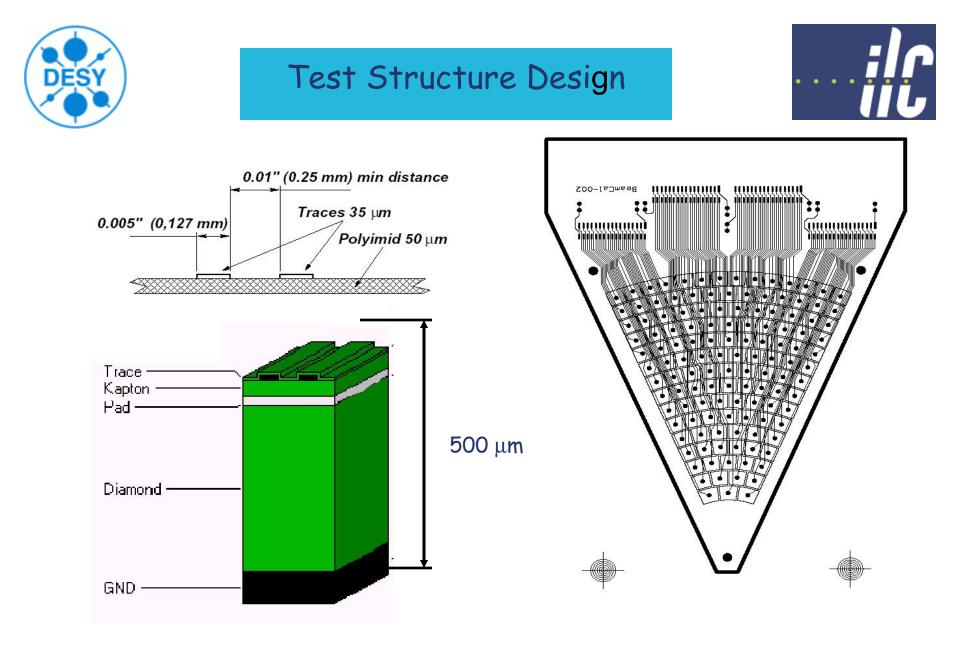


Polarization Model: CCD vs dose

(Assuming linear dependence of trap density vs dose)







Prototype readout structure

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Capton foil with conductive traces

PCB with pad structure

mining)

metal pads bonded to capton readout

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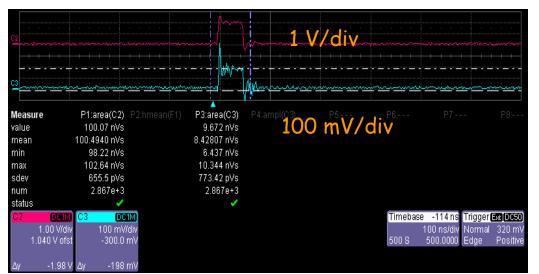
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Readout structure prototype with



Prototype results



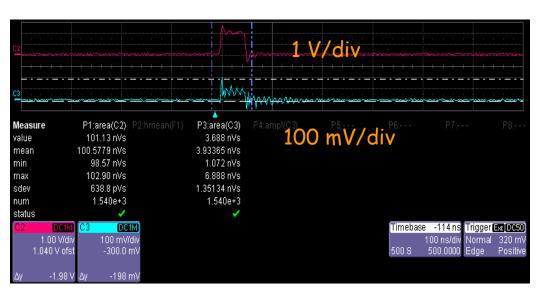


Simple experiment with signal generator and scope

Signal to crosstalk ratio approx 100/8 i.e. 8% crosstalk @ 9.5 pF input capacitance



Trace-to-Pad capacitance approx 0.8 pF





Summary



- Both poly- and single-crystalline CVD sensors stood the absorbed doses of several MGy and still able to operate properly
- GaAs sensors were operational after 500 kGy (but have larger dark current w.r.t. diamond)
- Strong polarization effects are observed in the radiation damaged sCVD
- Polarization Model is in a good agreement with observed phenomena
- Some steps towards the Readout Plane prototyping:
 - PCB simulating Readout pad structure
 - capton-based PCB for signal collection
 - first cross-talk measurements had been done
- SPICE model for the Readout Plane simulation is prepared
- To be done:a lot